Electronic Patent Application Fee Transmittal					
Application Number:	10721916				
Filing Date:	24-Nov-2003				
Title of Invention:	Semiconductor package heat spreaders and fabrication methods therefor				
First Named Inventor:	Virgil Cotoco Ararao				
Filer:	Mikio Ishimaru/Meghan Calhoun				
Attorney Docket Number:	27-006				
Filed as Large Entity					
Utility Filing Fees					
Description	Fee Code Quantity Amount Sub-Total in USD(\$)				
Basic Filing:					
Pages:					
Claims:					
Miscellaneous-Filing:					
Petition:	1				
Patent-Appeals-and-Interference:					
Post-Allowance-and-Post-Issuance:					
Extension-of-Time:	- 21				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Miscellaneous:						
Request for continued examination	1801	1	790	790		
	Total in USD (\$)			790		